



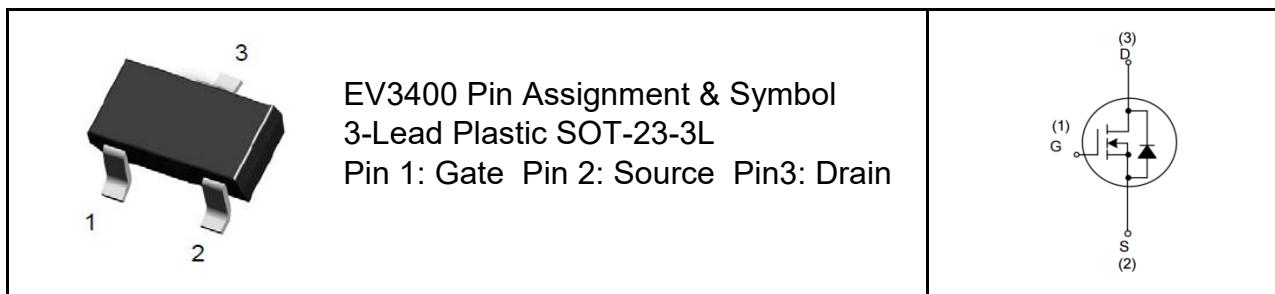
N-Channel Enhancement-Mode MOSFET (30V, 5.8A)

PRODUCT SUMMARY

V_{DSS}	I_D	$R_{DS(on)}$ (mΩ) Typ.
30V	5.8A	23@ VGS = 10 V, ID=5.8A
		25@ VGS = 4.5 V, ID=5.0A
		30@ VGS = 2.5V, ID=4.0A

Features

- Super high dense cell trench design for low RDS(on)
- Rugged and reliable
- SOT-23-3L package
- Lead (Pb) -free and halogen-free



Absolute Maximum Ratings ($T_A=25^\circ\text{C}$, unless otherwise noted)

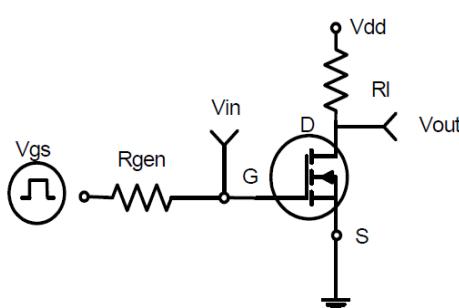
Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	± 12	V
I_D	Drain Current (Continuous)	5.8	A
I_{DM}	Drain Current (Pulsed) ^a	24	A
P_D	Total Power Dissipation @ $T_A=25^\circ\text{C}$	1.4	W
T_j, T_{stg}	Operating Junction and Storage Temperature Range	-55 to +150	°C
R_{QJA}	Thermal Resistance Junction to Ambient (PCB mounted) ^b	100	°C/W

a: Repetitive Rating: Pulse width limited by the maximum junction temperature.

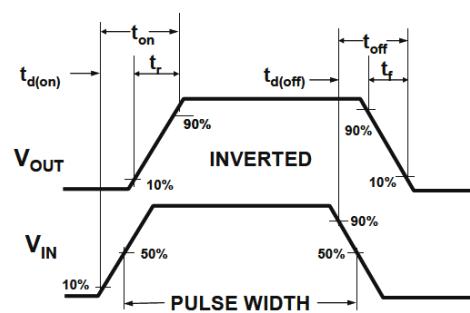
b: 1-in² 2oz Cu PCB board

**Electrical Characteristics** ($T_A=25^\circ\text{C}$, unless otherwise noted)

Symbol	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
• Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	30	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=30\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
• On Characteristics						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$	1	0.85	2	V
$R_{\text{DS(on)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=5.8\text{A}$	-	23	29	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=5\text{A}$		25	31	
		$V_{\text{GS}}=2.5\text{V}, I_{\text{D}}=4\text{A}$		30	42	
• Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}=15\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	-	560	-	PF
C_{oss}	Output Capacitance		-	58	-	
C_{rss}	Reverse Transfer Capacitance		-	47	-	
• Switching Characteristics						
Q_g	Total Gate Charge	$V_{\text{DS}}=15\text{V}, I_{\text{D}}=5\text{A}, V_{\text{GS}}=10\text{V}$	-	5.2	-	nC
Q_{gs}	Gate-Source Charge		-	0.9	-	
Q_{gd}	Gate-Drain Charge		-	1.6	-	
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=15\text{V}, R_L=3\Omega, I_{\text{D}}=1\text{A}, V_{\text{GEN}}=4.5\text{V}, R_G=3\Omega$	-	5	-	nS
t_r	Turn-on Rise Time		-	3	-	
$t_{\text{d(off)}}$	Turn-off Delay Time		-	16	-	
t_f	Turn-off Fall Time		-	4	-	
• Drain-Source Diode Characteristics						
V_{SD}	Drain-Source Diode Forward Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=-1\text{A}$	-	-	-1	V

Note: Pulse Test: Pulse Width $\leq 300\text{us}$, Duty Cycle $\leq 2\%$ 

Switching Test Circuit



Switching Waveforms



Typical Characteristics Curves (Ta=25°C, unless otherwise note)

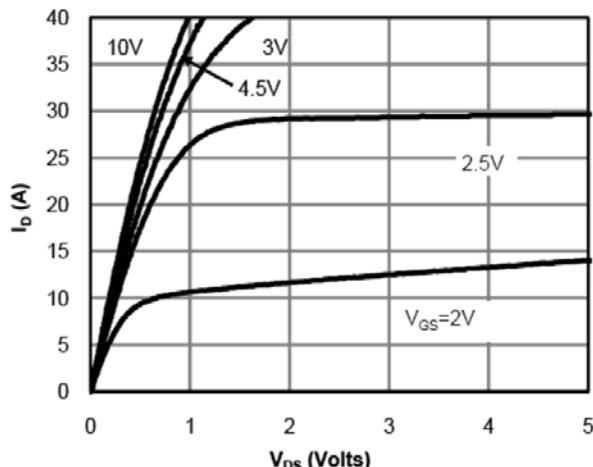


Fig 1: On-Region Characteristics (Note E)

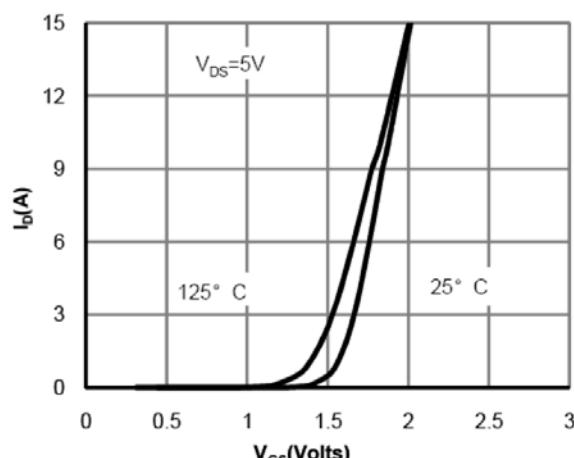


Figure 2: Transfer Characteristics (Note E)

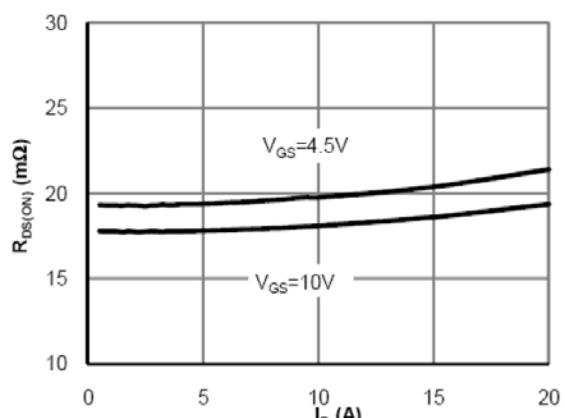


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

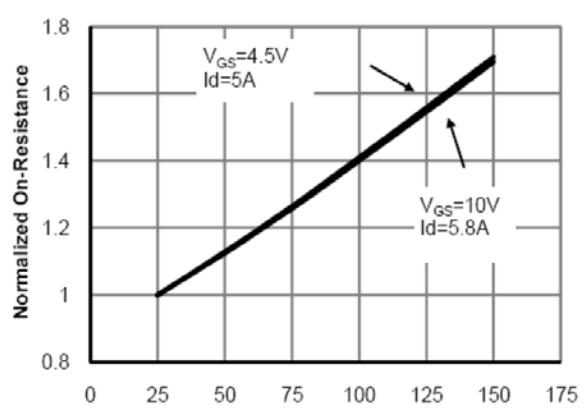


Figure 4: On-Resistance vs. Junction Temperature (Note E)

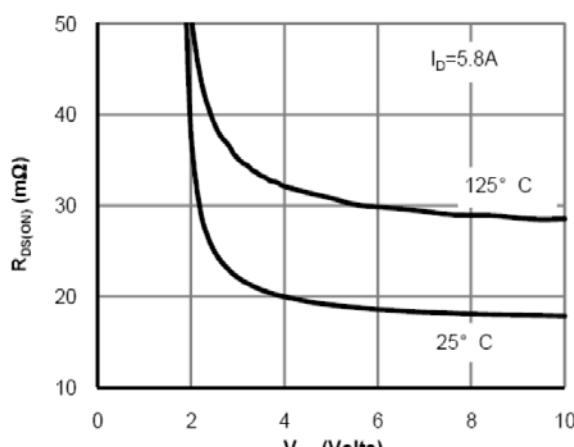


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

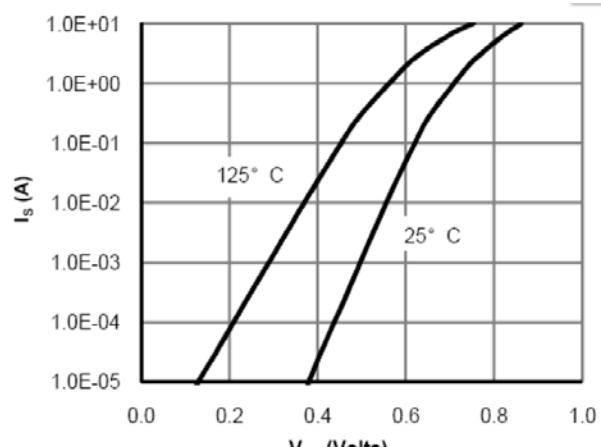


Figure 6: Body-Diode Characteristics (Note E)

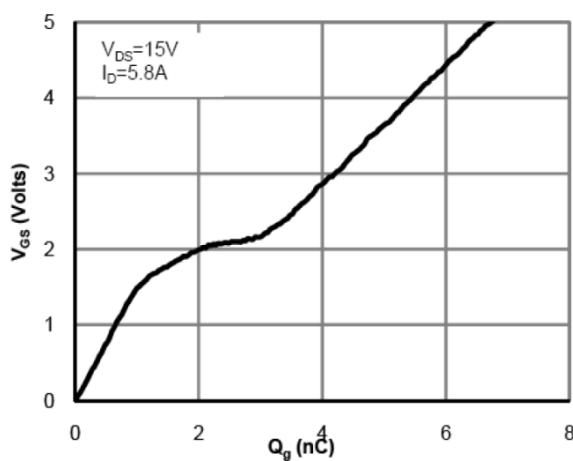


Figure 7: Gate-Charge Characteristics

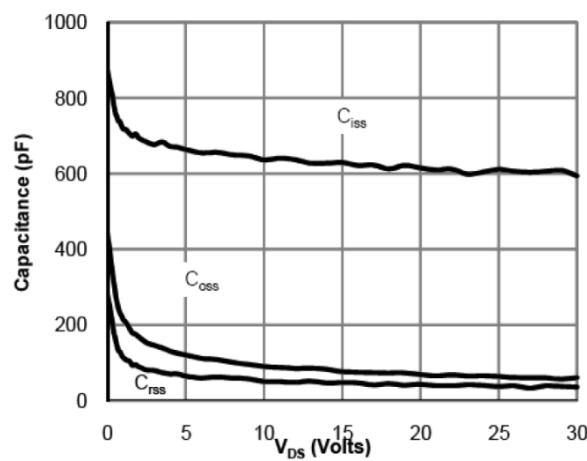


Figure 8: Capacitance Characteristics

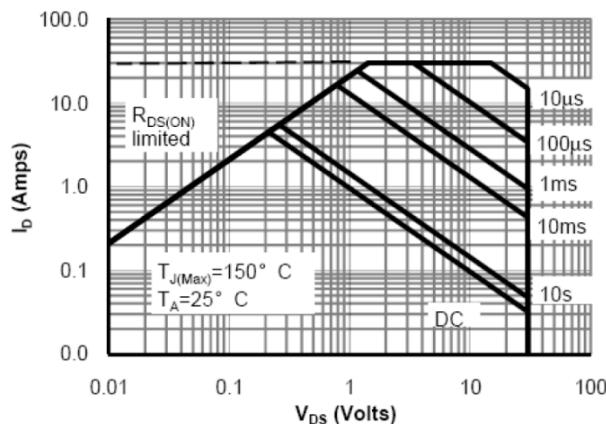


Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

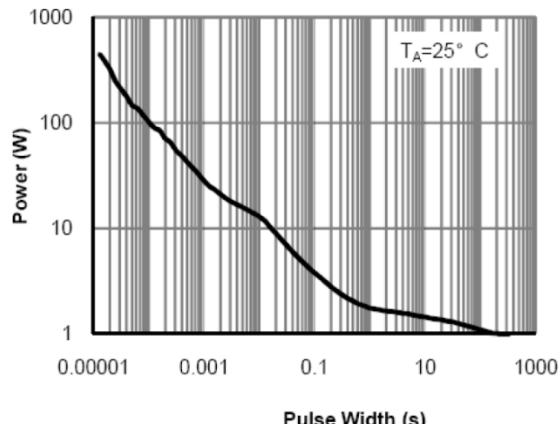


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

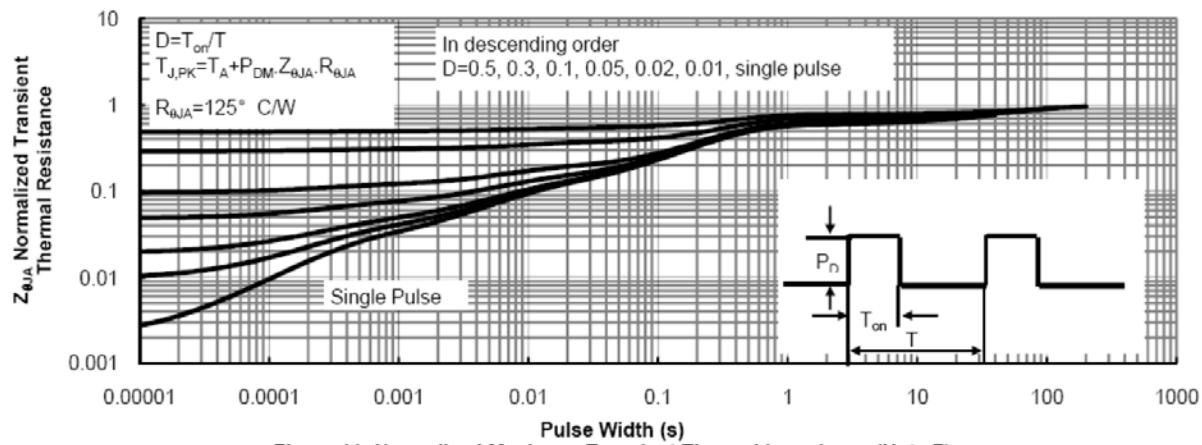


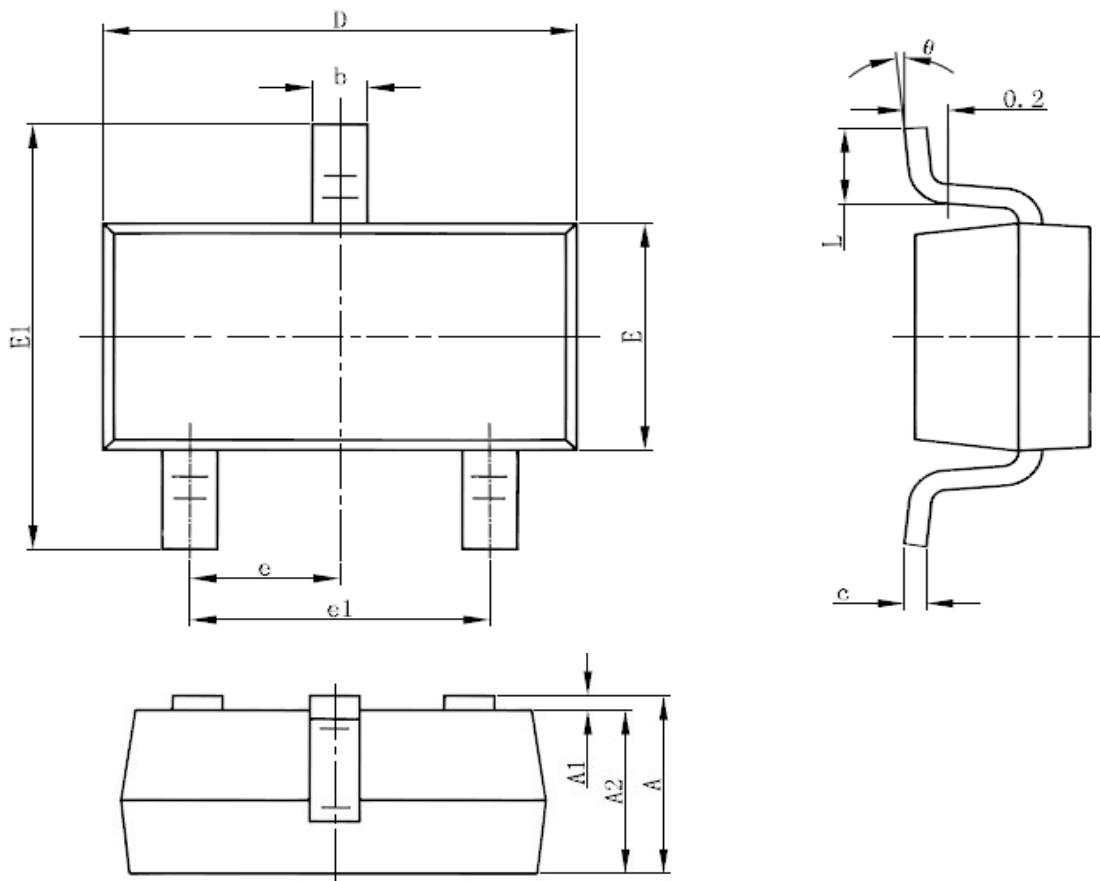
Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)



Eternal Semiconductor Inc.

EV3400

SOT23-3L PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.850	1.250	0.033	0.049
A1	0.000	0.100	0.000	0.004
A2	0.7	1.150	0.028	0.045
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.111	0.119
E	1.500	1.700	0.059	0.067
E1	2.650	2.950	0.104	0.116
e	0.950(BSC)		0.037(BSC)	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°